

Development of a Solid State Amplifier for the 3rd Harmonic Cavity for ALBA Synchrotron Light Source

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ALBA, a 3rd generation synchrotron light source

Required beam properties

- ✓ High brightness
- ✓ Small beam size
- ✓ large beam current



High electron density



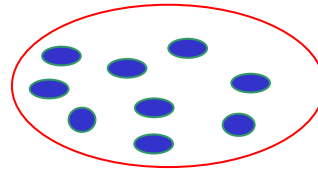
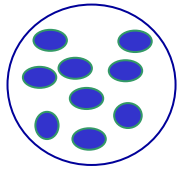
More electron collisions
per unit time



High beam losses
Small beam lifetime

3rd Harmonic RF System

Solution to reduce collisions



Stretch the bunch longitudinally by adding 3rd Harmonic RF system

Electron bunch (Beam size) with the main RF system

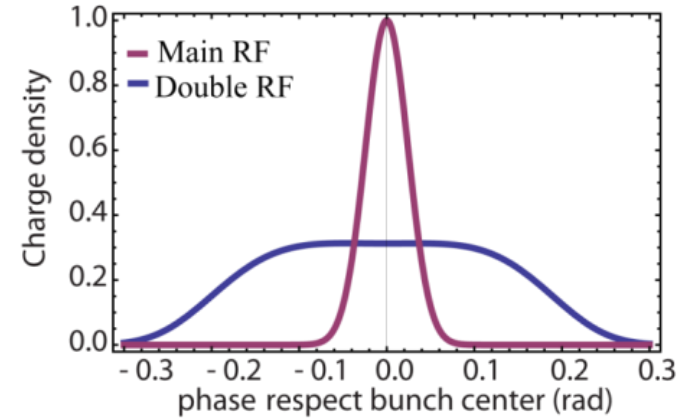
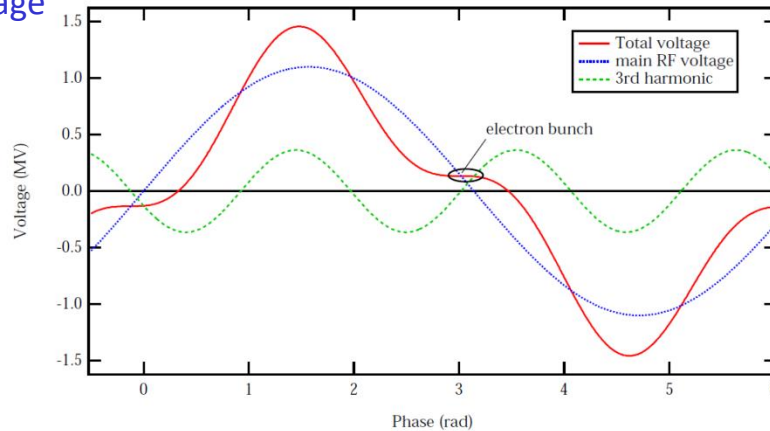
Electron bunch (Beam size) with the main and 3rd Harmonic RF system

The combined voltage from the main and 3rd Harmonic RF system is given by:

$$V(t) = V_{rf} \cdot \sin(\varphi + \varphi_s) + V_h \cdot \sin(n(\varphi + \varphi_h)) \quad h = 3$$

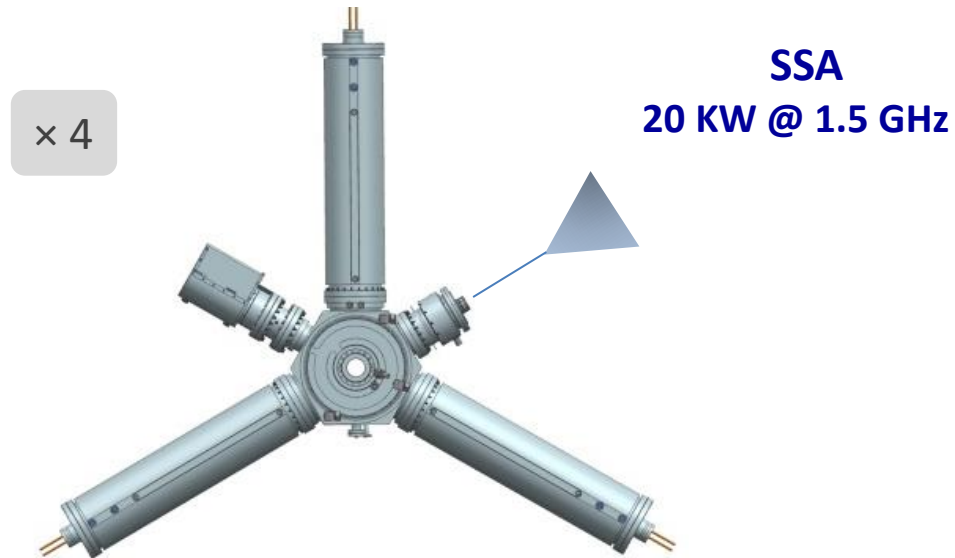
V_{rf} : main RF voltage

V_h : 3rd harmonic



Bunch length enlarged by a factor 2-3




3rd Harmonic RF system for ALBA Storage Ring



4 Scaled Dampy Cavities working @ 1.5 GHz
With V_h of 1 MV & Power/Cavity of 20 KW

Transistor's market comparison

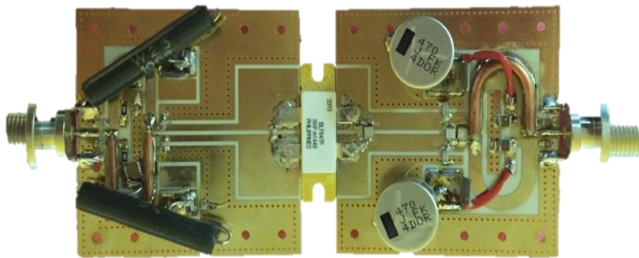
Study and comparison of technical characteristics of existing transistors

Transistor	Manufacture Part Number	Part Number	Date of production	Frequency (GHz)	Power (W)	Efficiency (%)	Gain (dB)	Price (€)
	BLF647P (NXP)	LDMOS (Si)	2013	HF-1.5	200	70	18	194.12
	CGHV14250 (CREE)	HEMT (GaN)	2014-2015	0.9-1.8	250	65	17	305.11
	CGHV14500 (CREE)	HEMT (GaN)	2014-2015	0.5-1.8	400	60	16	521.08

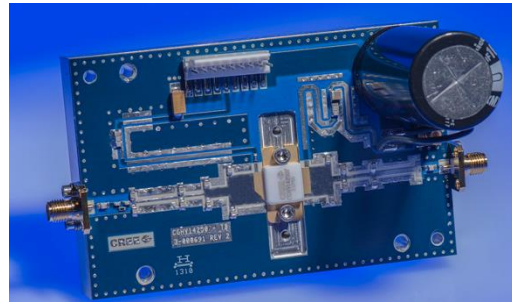
Transistor evaluation circuit (module)

Manufactured

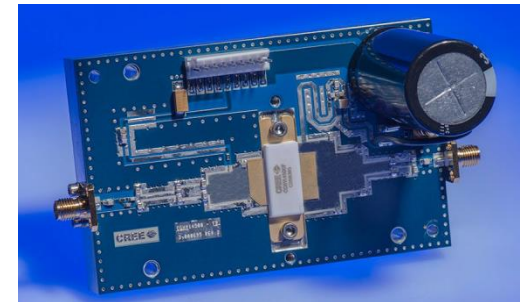
Purchased



BLF647P



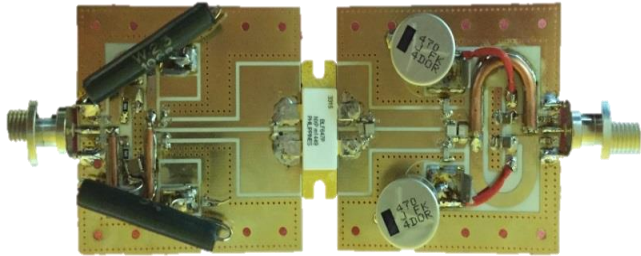
CGHV14250



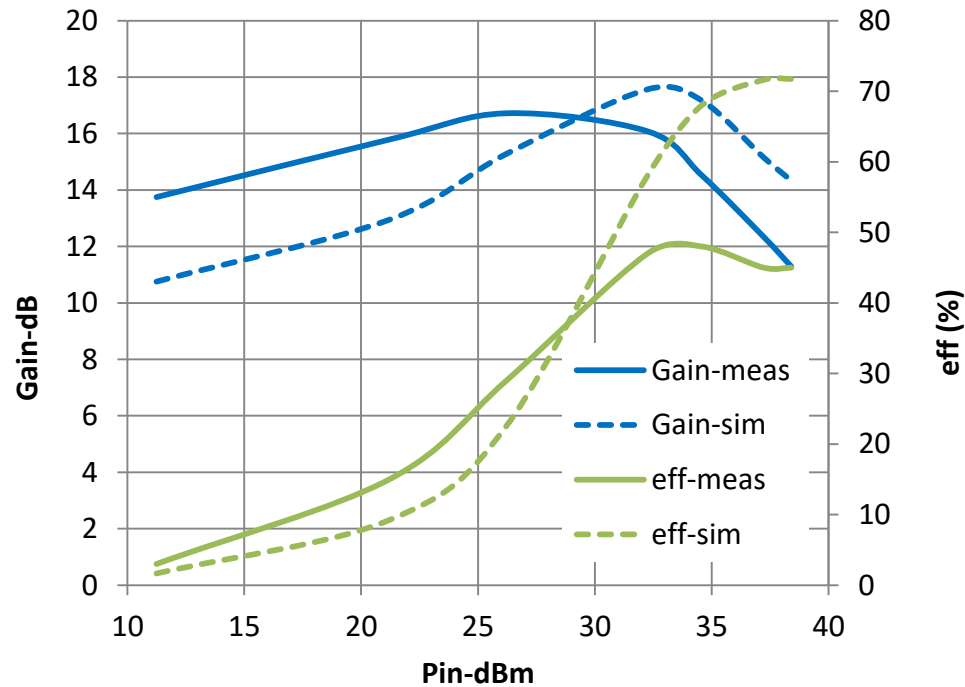
CGHV14500

BLF647P0 LDMOS (Si)- evaluation circuit

@ 1.3GHz CW , Idq: 100 mA , VDS: 32 V



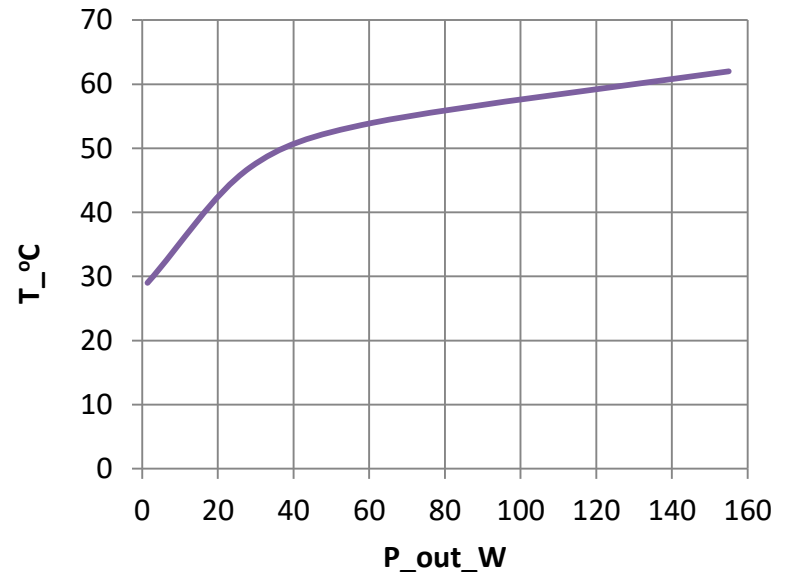
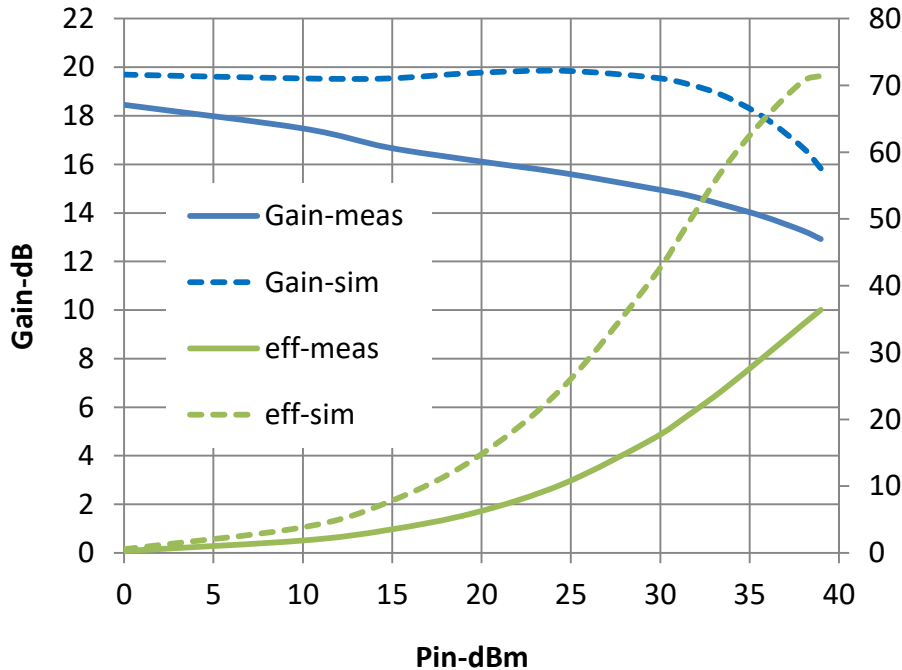
Characteristics	Simulation	Measurement
Power (W)	144	104
Gain (dB)	16.6	14.7
Efficiency (%)	70	55



@ 1.2GHz CW , Idq: 500 mA , VDS: 50 V, T_{case}: 50° C

Characteristics	Simulation	Measurement
Power (W)	441	155
Gain (dB)	17.4	12.93
Efficiency (%)	58	36.38

T_{case} as the measurement limitation
 Tests stopped due to **thermal** issues
 T_{case}: 64° C



CGHV14500 - HEMT (GaN)- evaluation circuit

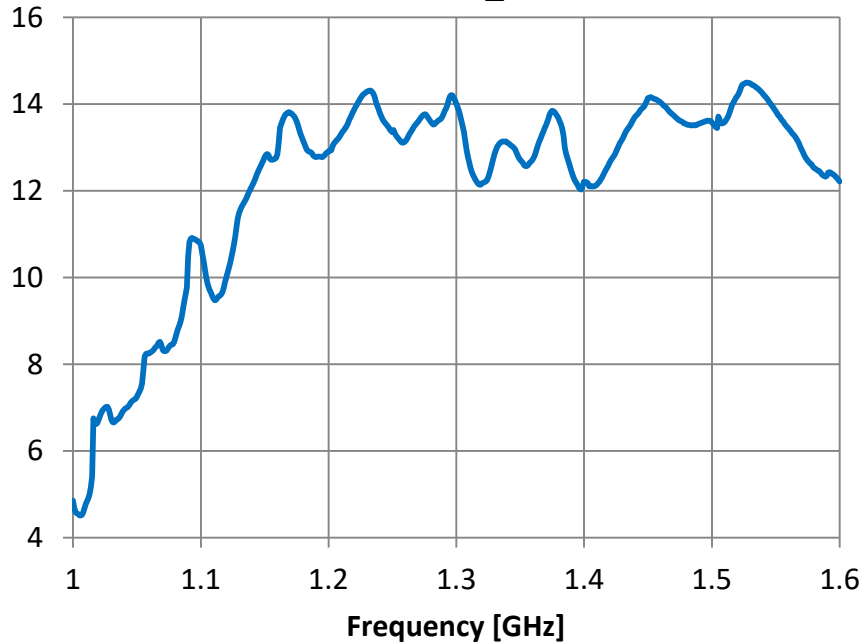
Fast sweep over the whole frequency range

Sweep time: 450 ms

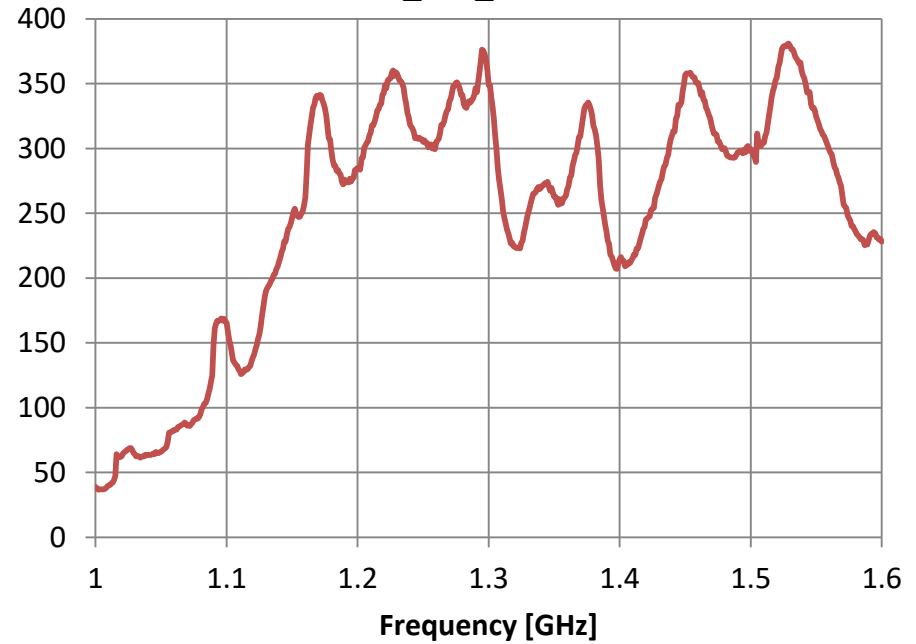
Max output power: 375 W @ 1.3GHz

Efficiency: 83%

Gain_dB



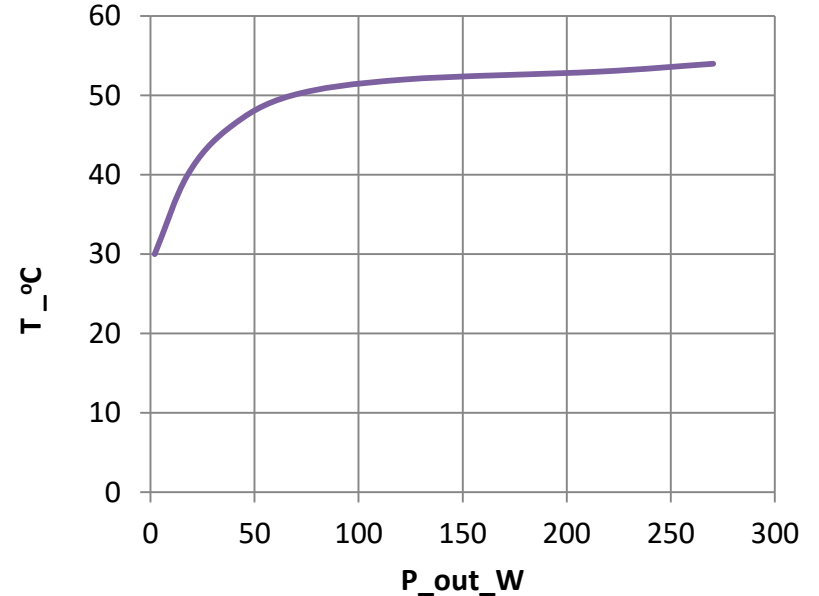
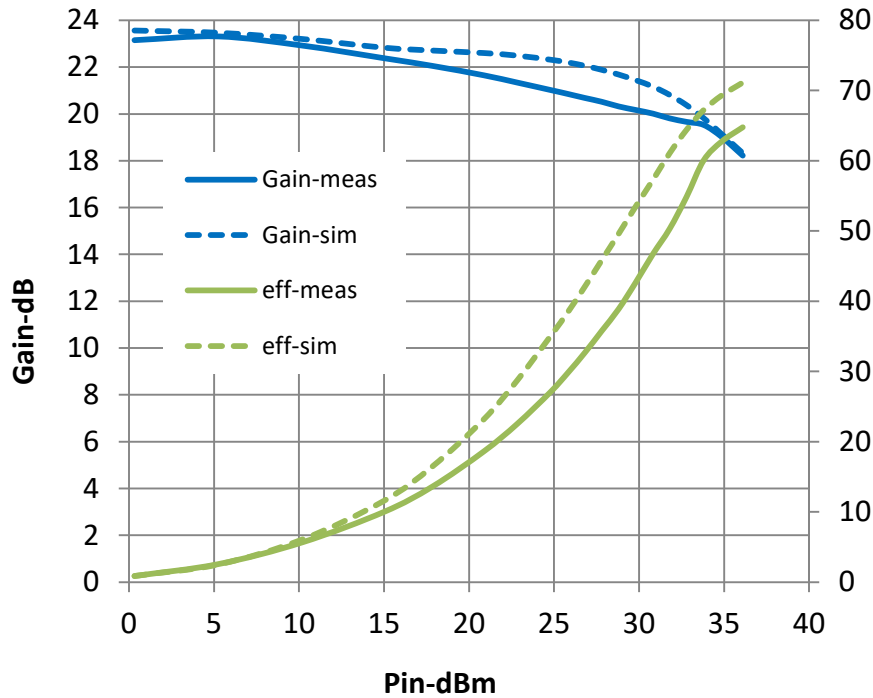
P_out_W



@ 1.2GHz CW , Idq: 500 mA , VDS: 50 V, T_{case}: 65° C

Characteristics	Simulation	Measurement
Power (W)	273	270.4
Gain (dB)	17.3	17.3
Efficiency (%)	69	64.77

Qualified enough to be selected

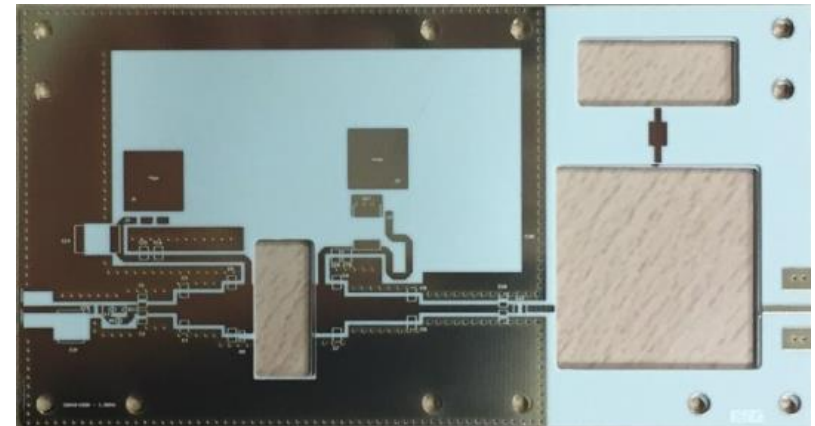
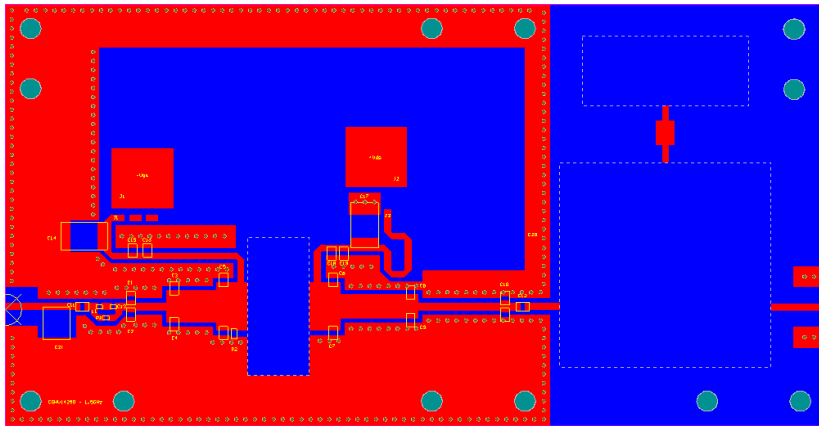
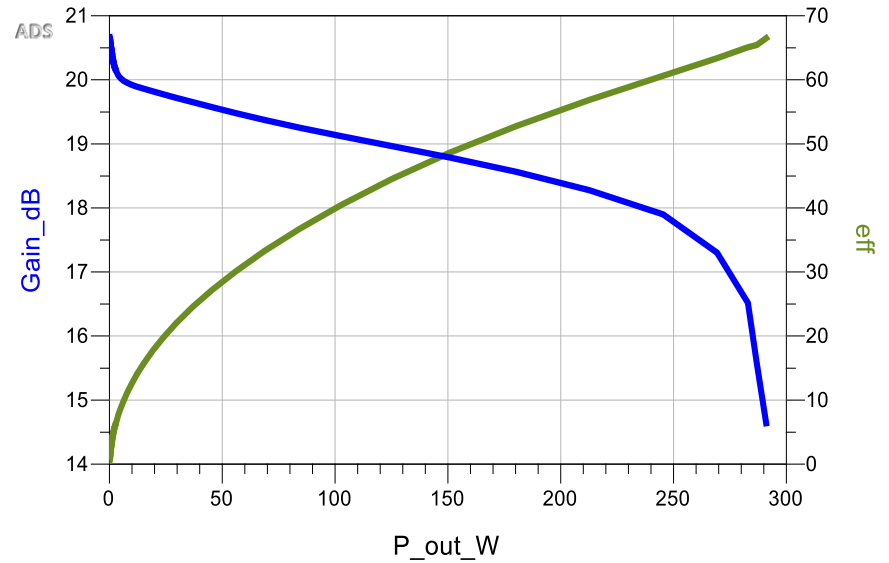


CGHV14250 HEMT(GaN)- single ended

- Frequency: 1.5 GHz
- Output power: 269 W
- Efficiency: 63%
- Gain: 17dB (at 1dB compression)
- Second Harmonic at -38 dBc
- RL: -13 dB

300 W circulator

- IL < 0.2 dB
- Isolation > 25 dB
- RL > 25 dB



250 W Solid State Power Amplifier module

PCB

Substrate: RO4003C

Thickness: 35 μ m

Height: 0.5 mm

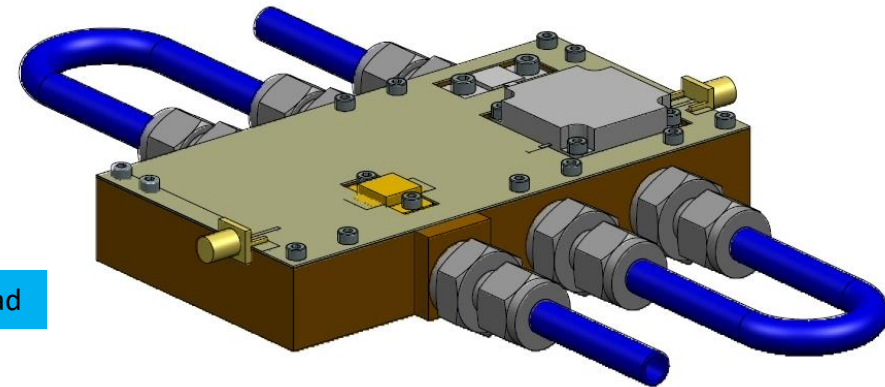
Dimension

without circulator: 89 \times 70 sq. mm

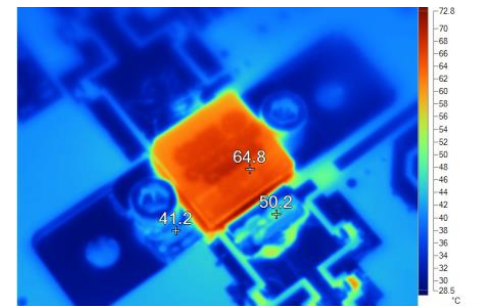
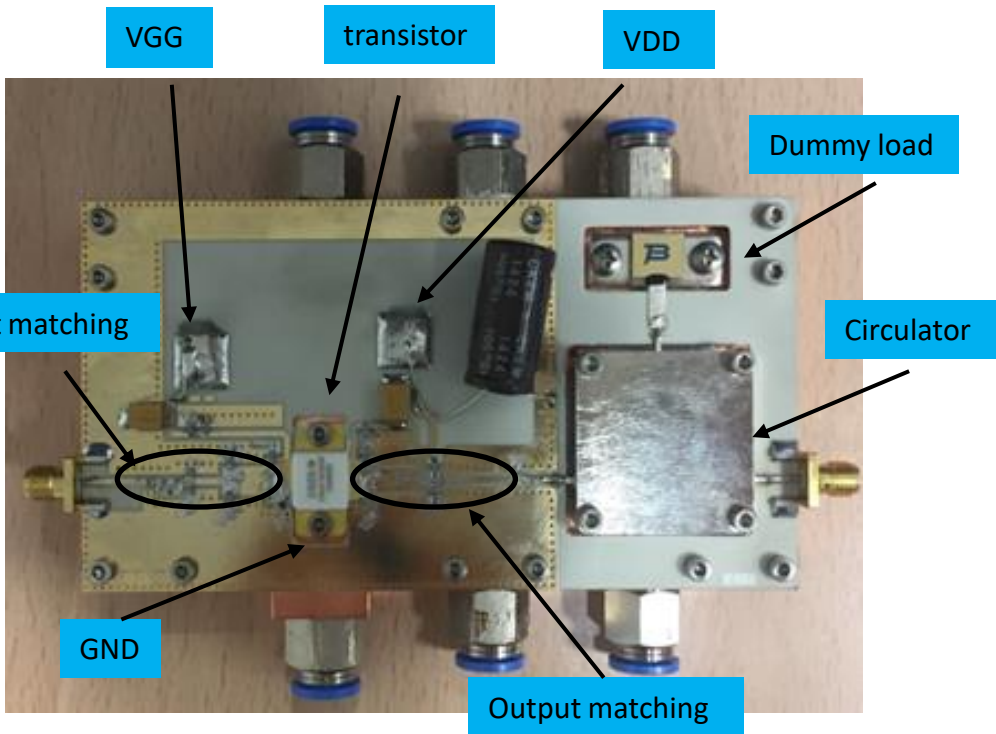
with circulator: 132 \times 70 sq. mm

Cooling System: Water

Water flow: 3 lit/min



Copper base plate

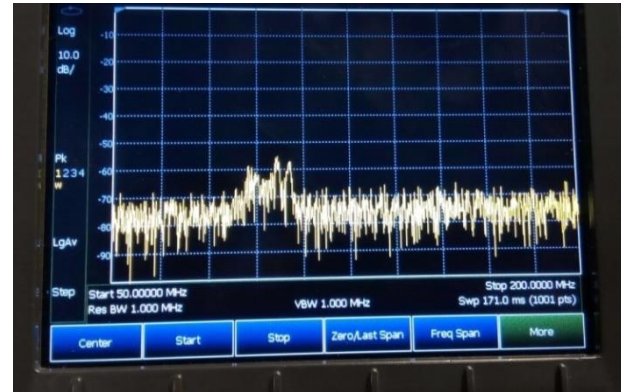
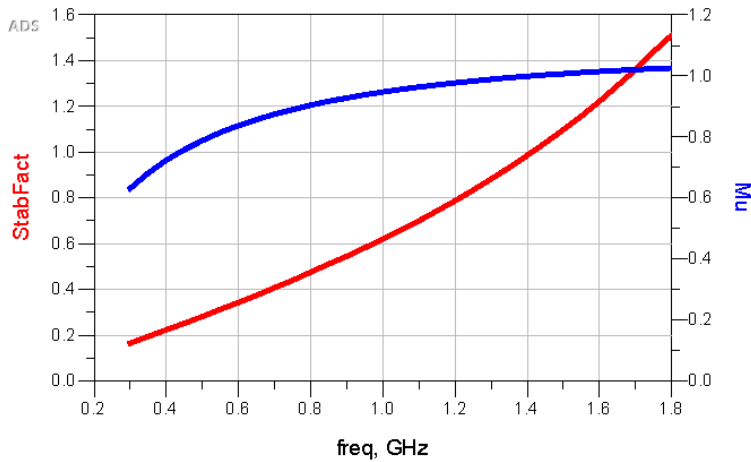


Thermal inspections

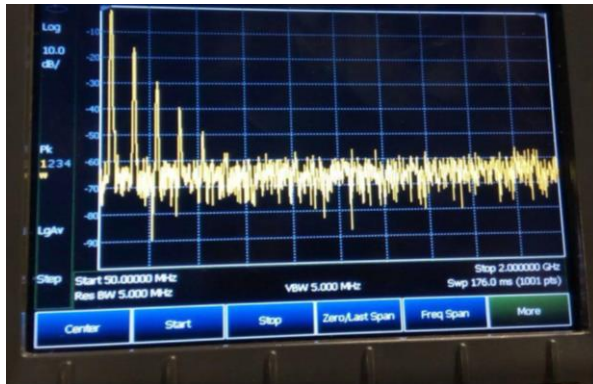
250 W Solid State Power Amplifier module

Stability test

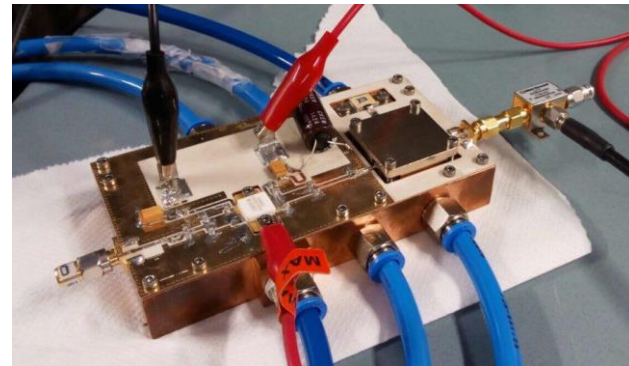
- Transistor is unstable in almost whole range of frequency based on **S-parameter S2P file & model**
- Very sensitive to bias voltage and T_{case}



PA is unstable from **80-110 MHz** without circulator at **bias point**



instability was seen at **VDS: 35 V**



PA is stable with circulator in

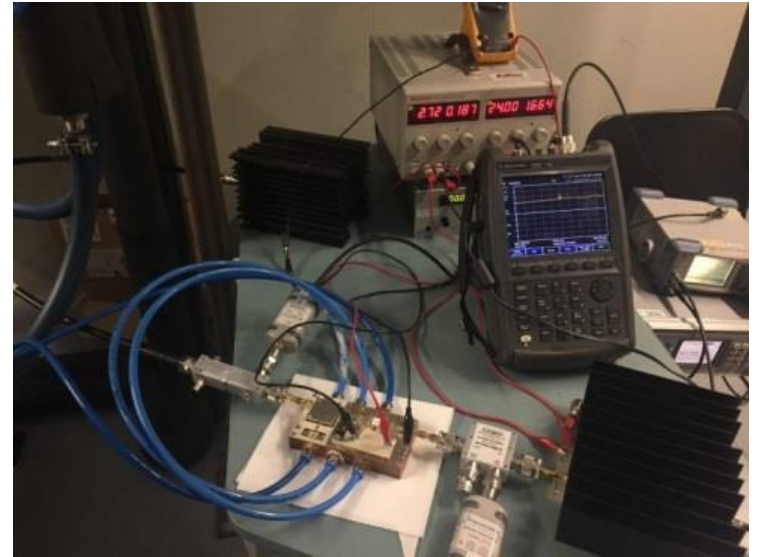
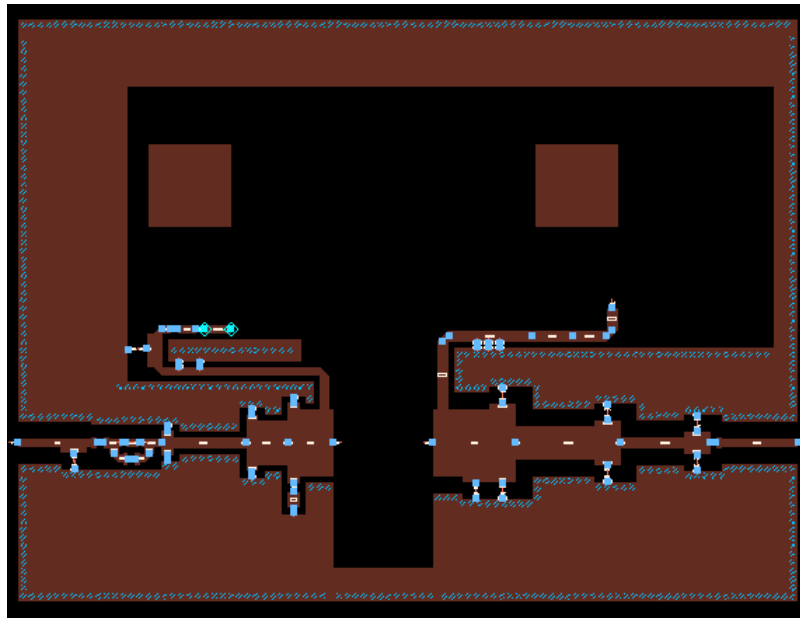
250 W Solid State Power Amplifier module

Due to Measurement obstacles as:

- Instability
- Lower gain
- Frequency shift
- Thermal issue

Modifications were done :

- output matching capacitors : ATC 600F → ATC 800B and trimmers
- output dc feed line width
- Parallel resistor for stabilization in the input matching

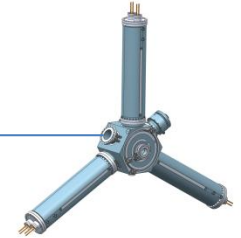
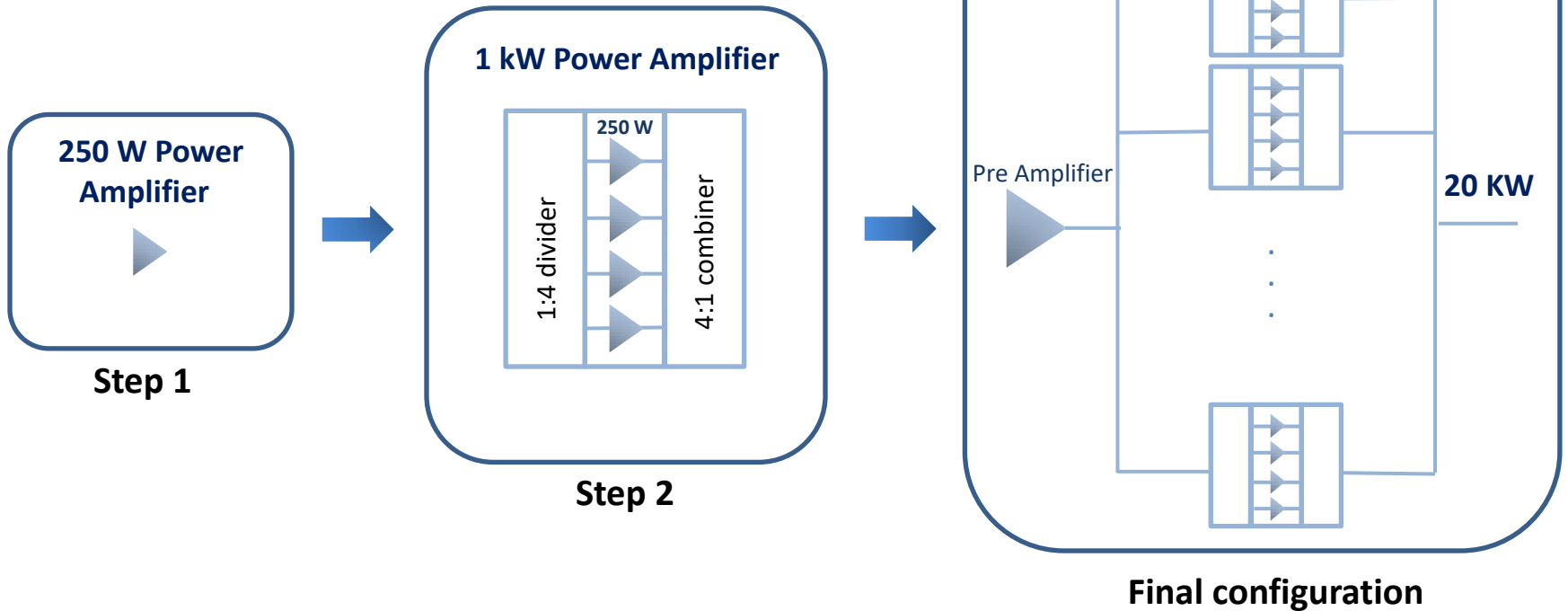


New Dimension: 94 × 70 sq. mm
Under fabrication

20 kW Solid State Power Amplifier Combining System

Parallel Combination Array

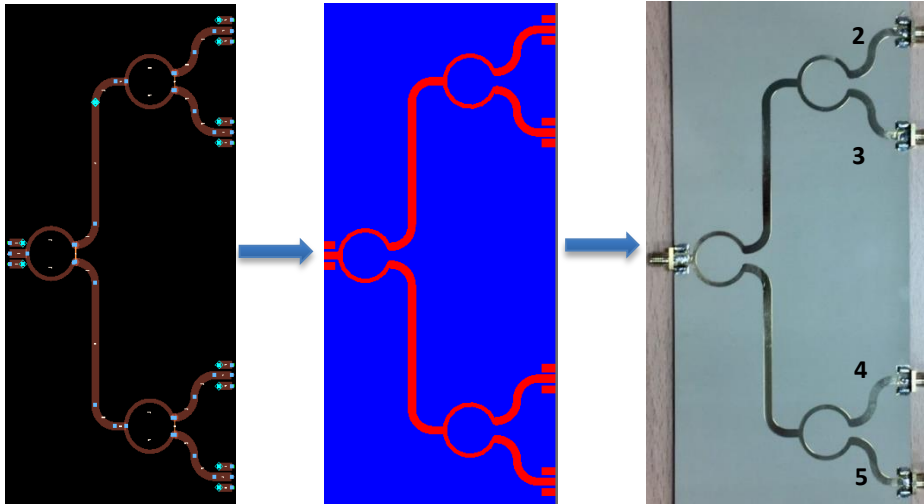
- ✓ Primary Power Amplifier module Output Power (Gain)
- ✓ Overall Output Power
- ✓ Dividers/Combiners (microstrip, coaxial & waveguide)



Wilkinson power divider/combiner

- Dimension: 100 × 284 sq. mm
- Substrate: RT6035HTC
- Thickness: 18 μ m
- Height: 1.6 mm

PORT	Freq (GHz)	Insertion loss Amplitude (IL) dB		Insertion loss (IL) Phase	
		Simulation	Measurement	Simulation	Measurement
2	1.5	-6.090	-6.374	166.148	-120.675
3	1.5	-6.136	-6.324	166.398	-119.283
4	1.5	-6.152	-6.329	165.027	-119.648
5	1.5	-6.106	-6.260	164.730	-118.496

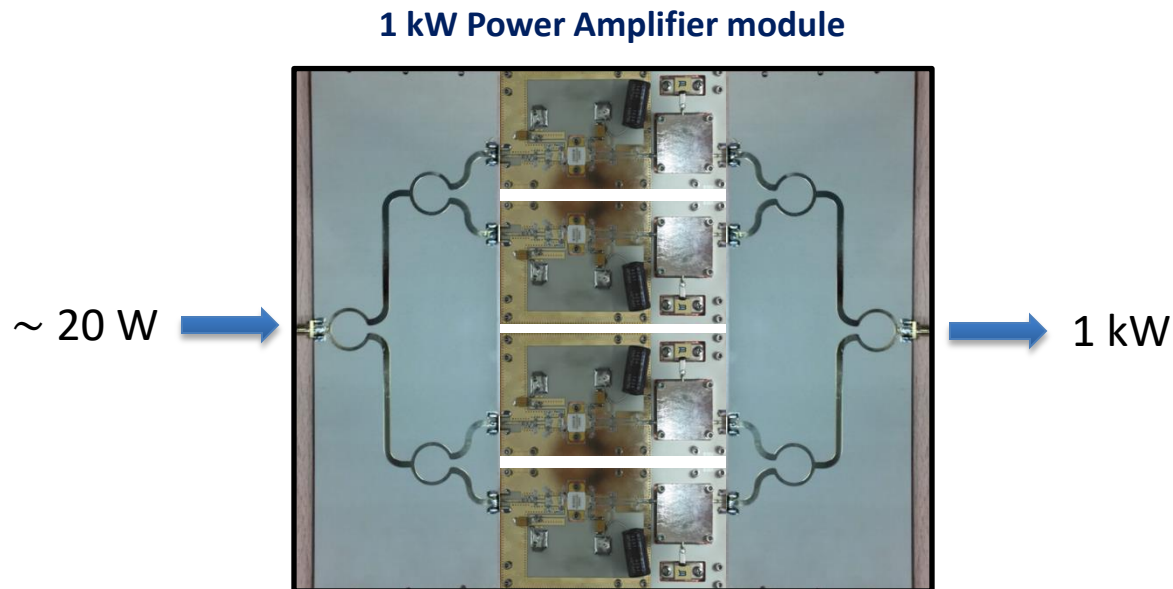


PORT	Freq (GHz)	Return loss (RL)	
		Amp (dB)	phase
1*-2	1.5	-23.18386572	137.1471727
1*-3	1.5	-23.13089724	136.658208
1*-4	1.5	-23.42375501	139.0671877
1*-5	1.5	-23.66775796	139.4849719

1 kW Solid State Power Amplifier module

Next Steps

- Optimization of 250 W module
- Design and build a 1 kW module out of 4 modules (cooling, casing)
- Optimization (amplitude and phase) of the 1 kW module



THANK YOU FOR YOUR ATTENTION